

MC68450

Technical Summary

Direct Memory Access Controller

M68000 microprocessors utilize state-of-the-art MOS technology to maximize performance and throughput. The MC68450 direct memory access controller (DMAC) is designed to complement the performance and architectural capabilities of M68000 Family microprocessors by moving blocks of data in a quick, efficient manner with minimum intervention from a processor. The DMAC performs memory-to-memory, memory-to-device, and device-to-memory data transfers by utilizing the following features:

- Four Independent DMA Channels with Programmable Priority
- Asynchronous M68000 Bus Structure with a 24-Bit Address and a 16-Bit Data Bus
- Fast Transfer Rates: Up to 4 Mbytes/Sec at 10 MHz, No Wait States
- Fully Supports All M68000 Bus Options such as Halt, Bus Error, and Retry
- FIFO Locked Step Support with Device Transfer Complete Signal
- Flexible Request Generation:

Internal, Maximum Rate
Internal, Limited Rate
External, Cycle Steal (With or Without Hold)

External, Burst

Mixed Internal and External

Programmable 8-Bit or 16-Bit Peripheral Device Types:

Explicitly Addressed:

M68000 Type

M6800 Type

Implicitly Addressed:

Device with Request and Acknowledge

Device with Request, Acknowledge, and Ready

Pin and Register Compatible Functional Superset of the MC68440 DDMA

This document contains information on a new product. Specifications and information herein are subject to change without notice.

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INTRODUCTION

The main purpose of a DMAC in any system is to transfer data at very high rates, usually much faster than a microprocessor under software control can handle. The term DMA is used to refer to the ability of a peripheral device to access memory in a system in the same manner as a microprocessor does. DMA operation can occur concurrently with other microprocessor operations, thus greatly boosting overall system performance.

Figure 1 illustrates a typical system configuration using a DMA interface to a high-speed disk storage device. In a system such as this, the DMAC moves blocks of data between the peripheral controllers and memory at rates approaching the limits of the memory bus since data movement is implemented in high-speed MOS hardware. A block of data consists of a sequence of byte, word, or long-word operands starting at a specific address in memory with the length of the block determined by a transfer count. A single channel operation may involve the transfer of several blocks of data between the memory and a device.

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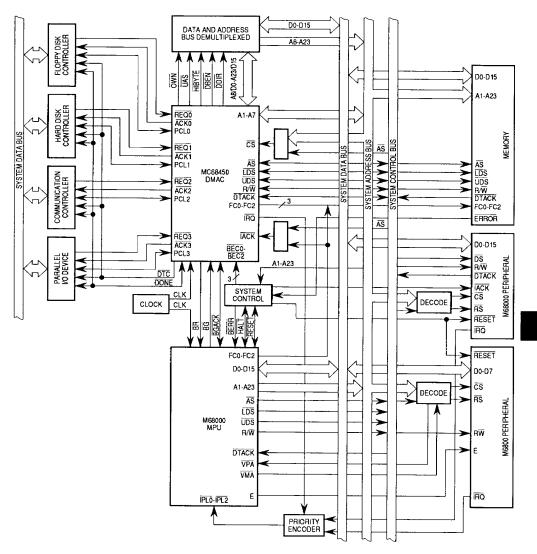


Figure 1. Typical M68000-Based System Configuration

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Any operation involving the DMAC follows the same basic steps: channel initialization by the main processor, data transfer, and block termination. In the initialization phase, the host processor loads the registers of the DMAC with control information, address pointers, and transfer counts and then starts the channel. During the transfer phase, the DMAC accepts requests for operand transfers and provides addressing and bus control for the transfers. The termination phase occurs after the operation is complete when the DMAC indicates the status of the operation in the status register. During all phases of a data transfer operation, the DMAC will be in one of three operating modes:

- IDLE The DMAC enters this state when it is reset by an external device and waiting for initialization by the main processor or an operand transfer request from a peripheral.
- MPU The DMAC enters this state when selected by another bus master in the system (usually the main processor). In this mode, the DMAC internal registers are written or read to control channel operation or to check the status of a block transfer.
- DMA The DMAC enters this state when acting as a bus master to perform an operand transfer.

In addition to fully supporting the M68000 Family bus, the DMAC also supports transfers to or from M6800 Family peripheral devices. Figure 2 illustrates a typical system configuration utilizing an M6800-type peripheral device.

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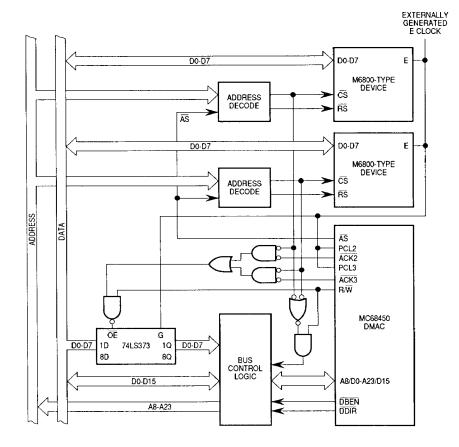


Figure 2. Typical System Configuration with M6800-Type Peripheral Devices

OPERAND TRANSFER MODES

The DMAC can perform implicitly addressed or explicitly addressed data transfers using any of the following protocols:

- 1. Explicitly addressed, MC68000-compatible device
- 2. Explicitly addressed, MC6800-compatible devices
- 3. Implicitly addressed, device with request and acknowledge
- 4. Implicitly addressed, device with request, acknowledge, and ready

During protocols 1 and 2, data is transferred from the source to an internal DMAC holding register, and then moved from the holding register to the des-

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tination on the next bus cycle. Protocols 3 and 4 require only one bus cycle for data transfer since only one device needs to be addressed. With these protocols, communication is performed using a two-signal and three-signal handshake, respectively.

Implicitly addressed devices do not require the generation of a device data register address for a data transfer. Such a device is controlled by a five-signal device control interface on the DMAC during implicit address transfers (see Figure 3). Since only memory is addressed during such a data transfer, this method is called the single-address method.

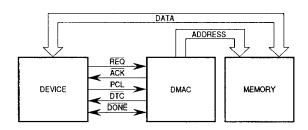


Figure 3. Implicitly Addressed Device Interface

Explicitly addressed devices require that a data register within the peripheral device be addressed. No signals other than the M68000 asynchronous bus control signals are needed to interface with such a device, although any of the five-device control signals may be used. Because the address bus is used to access the peripheral, the data cannot be directly transferred to/from memory since memory also requires addressing. Therefore, data is transferred from the source to an internal holding register in the DMAC and then transferred to the destination during a second bus transfer (see Figure 4). Since both memory and the device are addressed during such a data transfer, this method is called the dual-address method.

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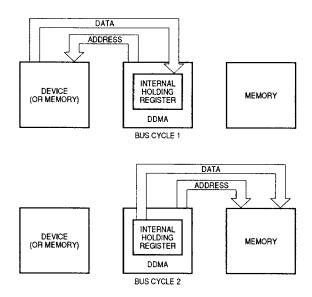


Figure 4. Dual-Address Transfer Sequence

CHANNEL OPERATING MODES

There are three types of channel operations: 1) single block transfers, 2) continued operation, and 3) chained operations. The first two modes utilize on-chip registers; whereas, the last mode uses an on-chip address register to point to address and to count parameters stored in system memory.

When transferring single blocks of data, the memory address and device address registers are initialized by the user to specify the source and destination of the transfer. The memory transfer count register is also initialized to count the number of operands transferred in a block. Repeated transfers are possible with the continued mode of operation, where the memory address and transfer count registers are automatically loaded from internal registers upon completion of a block transfer (see Figure 5).

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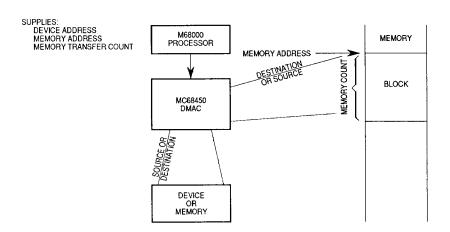


Figure 5. Single Block Transfer

The two chaining modes are array chaining and linked array chaining. The array chaining mode operates from a contiguous memory array consisting of memory addresses and transfer counts. The base address register and base transfer count register are initialized to point to the beginning address of the array and the number of array entries, respectively. As each block transfer is completed, the next entry is fetched from the array, the base transfer count is decremented, and the base address is incremented to point to the next array entry. When the base transfer count reaches zero, the entry just fetched is the last block transfer defined in the array (see Figure 6).

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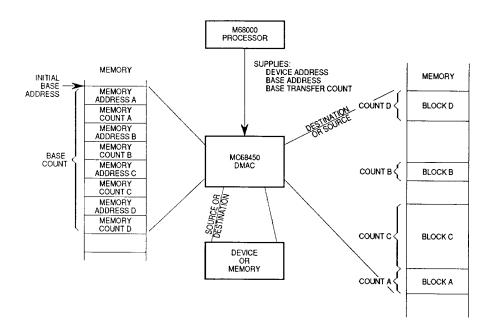


Figure 6. Array Chaining Transfer

The linked array chaining mode is similar to the array chaining mode, except that each entry in the memory array also contains a link address pointing to the next entry in the array. This method allows a noncontiguous memory array. The last entry contains a link address set to zero. No base transfer count register is needed in this mode. The base address register is initialized to the address of the first entry in the array. The link address is used to update the base address register at the beginning of each block transfer. This chaining mode allows array entries to be easily moved or inserted without reorganizing the array into sequential order. Also, the number of entries in the array need not be specified to the DMAC (see Figure 7).

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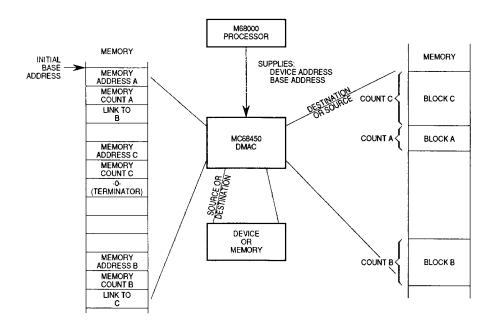


Figure 7. Linked Array Chaining Transfer

INTERRUPT OPERATION

The DMAC will interrupt the MPU for a number of occurrences, such as the completion of a DMA operation or at the request of a peripheral device using a peripheral control line. The user must write interrupt vectors into an on-chip vector register for use in the M68000 vectored interrupt structure. Two vector registers are available for each channel.

CHANNEL PRIORITY

Each channel may be given a priority level of 0, 1, 2, or 3. If several channel requests occur at the same priority level, a round-robin is entered automatically.

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REQUEST MODES

Requests may be externally generated by a device or internally generated by the auto-request mechanism of the DMAC. Auto-requests may be generated either at the maximum rate, where the channel always has a request pending, or at a limited rate determined by selecting a portion of the bus bandwidth to be available for DMA activity. External requests can be either burst requests or cycle-steal requests generated by the request signal associated with each channel.

REGISTERS

The DMAC contains 17 registers for each of four channels plus one general control register, all of which are under complete software control. The user programmer's model of the registers is shown in Figure 8.

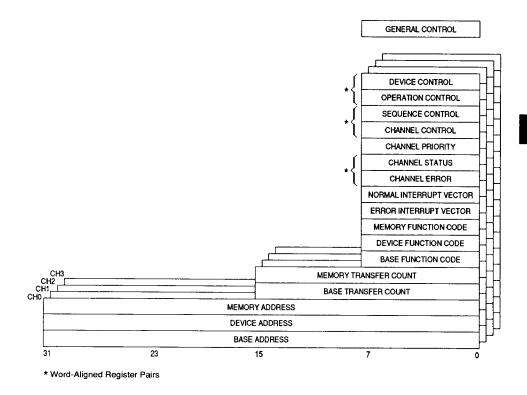


Figure 8. Programmer's Model

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The DMAC registers contain information about the data transfers such as the source and destination address and function codes, transfer count, operand size, device port size, channel priority, continuation address and transfer count, and the function of the peripheral control line. One register also provides status and error information on channel activity, peripheral inputs, and various events that may have occurred during a DMA transfer. A general control register selects the bus utilization factor to be used in limited-rate auto-request DMA operations.

SIGNAL DESCRIPTION

The following paragraphs contain a brief description of the DMAC input and output signals. Included at the end of the functional description of the signals is a table describing the electrical characteristics of each pin (i.e., the type of driver used).

NOTE

The terms assertion and negation will be used extensively to avoid confusion when dealing with a mixture of active-low and active-high signals. The term assert or assertion is used to indicate that a signal is active or true, independent of whether that level is represented by a high or low voltage. The term negate or negation is used to indicate that a signal is inactive or false.

SIGNAL ORGANIZATION

The input and output signals can be functionally organized into the groups shown in Figure 9. The signal functions are discussed in the following paragraphs.

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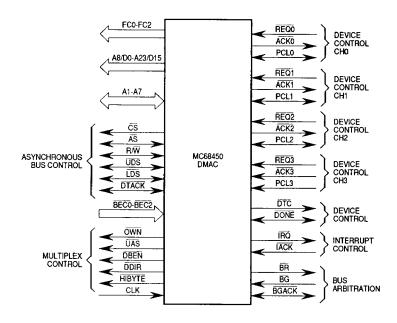


Figure 9. Functional Signal Organization

Address/Data Bus (A8/D0-A23/D15)

This 16-bit bus is time multiplexed to provide address outputs during the DMA mode of operation and is used as a bidirectional data bus to input data from an external device (during an MPU write or DMA read) or to output data to an external device (during an MPU read or a DMA write). This three-state bus is demultiplexed using external latches and buffers controlled by the multiplex control lines.

Lower Address Bus (A1-A7)

These bidirectional three-state signals are used to address the DMAC internal registers in the MPU mode and to provide the lower seven address outputs in the DMA mode.

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Function Codes (FC0–FC2)

These three-state outputs are used in the DMA mode to further qualify the value on the address bus to provide eight separate address spaces that may be defined by the user. The value placed on these lines is taken from one of the internal function code registers, depending on the register that provides the address used during a DMA bus cycle.

Asynchronous Bus Control

Asynchronous data transfers are handled using the following control signals: chip select, address strobe, read/write, upper and lower data strobes, and data transfer acknowledge. These signals are described in the following paragraphs.

- CHIP SELECT (CS). This input selects the DMAC for an MPU bus cycle. When CS is asserted, the address on A1–A7 and the data strobes (or A when using an 8-bit bus) select the internal DMAC register that will be involved in the transfer. CS should be generated by qualifying an address decode signal with the address and data strobes.
- ADDRESS STROBE (AS). This bidirectional signal is an output in the DMA mode to indicate that a valid address is present on the address bus. In the MPU or IDLE modes, AS is an input to determine when the DMAC can take control of the bus (if the DMAC has requested and been granted use of the bus).
- **READ/WRITE (R/W).** This bidirectional signal indicates the direction of a data transfer during a bus cycle. In the MPU mode, a high level indicates that a transfer is from the DMAC to the data bus, and a low level indicates a transfer from the data bus to the DMAC. In the DMA mode, a high level indicates a transfer from the addressed memory or device to the data bus, and a low level indicates a transfer from the data bus to the addressed memory or device.
- **UPPER AND LOWER DATA STROBE (UDS, LDS).** These bidirectional signals indicate when data is valid on the bus and what portions of the bus should be involved in the transfer.
- DATA TRANSFER ACKNOWLEDGE (DTACK). This bidirectional signal denotes that an asynchronous bus cycle may be terminated. In the MPU mode, this output indicates that the DMC has accepted data from the MPU or placed data on the bus for the MPU. In the DMA mode, this input is monitored by the DMAC to determine when to terminate a bus cycle. As long as DTACK remains negated, the DMAC will insert wait cycles into a bus cycle; when DTACK is asserted, the bus cycle will be terminated (except when PCL is used as a ready signal, in which case both signals must be asserted before the cycle is terminated).

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BUS EXCEPTION CONTROL (BECO-BEC2). These inputs provide an encoded signal that indicates an abnormal bus condition such as a bus error or reset.

Multiplex Control

These signals are used to control external multiplex/demultiplex devices to separate the address and data information on the A8/D0–A23/D15 lines and to transfer data between the upper and lower halves of the data bus during certain DMA bus cycles.

Figure 10 shows the five external devices needed to demultiplex the address/data pins and the interconnection of the multiplex control signals. The SN74LS245 that can connect the upper and lower halves of the data bus is needed only if an 8-bit device is used during single address transfers.

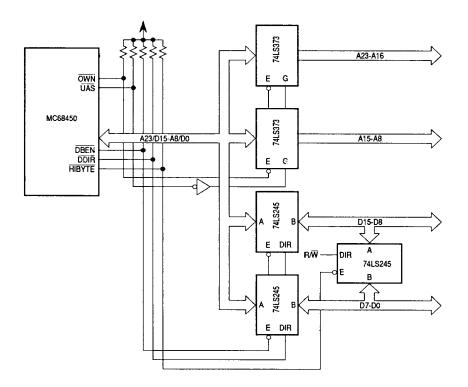


Figure 10. Demultiplex Logic

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- **OWN** (**OWN**). This three-state output indicates that the DMAC is controlling the bus. It is used as the enable signal to turn on the external address drivers and control signal buffers.
- **UPPER ADDRESS STROBE (UAS)**. This three-state output is used as the gate signal to the transparent latches that capture the value of A8–A23 on the multiplexed address/data bus.
- **DATA BUFFER ENABLE (DBEN)**. This three-state output is used as the enable signal to the external bidrectional data buffers.
- **DATA DIRECTION (DDIR).** This three-state output controls the direction of the external bidirectional data buffers. If DDIR is high, the data transfer is from the DMAC to the data bus. If DDIR is low, the data transfer is from the data bus to the DMAC.
- **HIGH BYTE** (**HIBYTE**). This three-state output indicates that data present on data lines D8–D15 must be transferred to data lines D0–D7, or vice versa, through an external buffer during a single address transfer between an 8-bit device and memory.

Bus Arbitration Control

These three signals form a bus arbitration circuit used to determine which device in a system will be the current bus master.

- **BUS REQUEST (BR).** This output is asserted by the DMAC to request control of the bus.
- BUS GRANT (BG). This input is asserted by an external bus arbiter to inform the DMAC that it may assume bus mastership as soon as the current bus cycle is completed. The DMAC will not take control of the bus until CS, IACK, AS, and BGACK are all negated.
- BUS GRANT ACKNOWLEDGE (BGACK). This bidirectional signal is asserted by the DMAC to indicate that it is the current bus master. BGACK is monitored as an input to determine when the DMAC can become bus mater and if a bus master other than the system MPU is a master during limited-rate auto-request operation.

Interrupt Control

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These two signals form an interrupt request/acknowledge handshake circuit with an MPU.

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- **INTERRUPT REQUEST (IRQ)**. This output is asserted by the DMAC to request service from the MPU.
- INTERRUPT ACKNOWLEDGE (IACK). This input is asserted by the MPU to acknowledge that it has received an interrupt from the DMAC. In response to the assertion of IACK, the DMAC will place a vector on D0–D7 that will be used by the MPU to fetch the address of the proper DMAC interrupt handler routine.

Device Control

These signals perform the interface between the DMAC and four peripheral devices. Four sets of three lines are dedicated to a single DMAC channel and its associated peripheral; the remaining two lines are global signals shared by all channels.

- **REQUEST** (**REQ0**–**REQ3**). These inputs are asserted by a peripheral device to request an operand transfer between that peripheral device and memory. In the cycle-steal request generation mode, these inputs are edge sensitive; in burst mode, they are level sensitive.
- **ACKNOWLEDGE (ACKO-ACK3)**. These outputs are asserted by the DMAC to signal to a peripheral that an operand is being transferred in response to a previous transfer request.
- **PERIPHERAL CONTROL LINE (PCL0–PCL3).** These bidirectional lines are multipurpose signals that may be programmed to function as ready, abort, reload, status, interrupt, or enable clock inputs or as start pulse outputs.
- **DATA TRANSFER COMPLETE (DTC)**. This output is asserted by the DMAC during any DMAC bus cycle to indicate that data has been successfully transferred (i.e., the bus cycle was not terminated abnormally).
- **DONE** (DONE). This bidirectional signal is asserted by the DMAC or a peripheral device during any DMA bus cycle to indicate that the data being transferred is the last item in a block. The DMAC will assert this signal during a bus cycle when the memory transfer count register is decremented to zero. On a linked array chaining mode, the $\overline{\text{DONE}}$ signal is asserted after all the blocks have been transferred. Because this signal has two purposes, make sure that a pullup resistor (1k–2k Ω) is tied to this signal to ensure that no interchannel interactions occur.

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Clock (CLK)

The clock input is a TTL-compatible signal that is internally buffered for development of the internal clocks needed by the DMAC. The clock input should not be gated off at any time, and the clock signal must conform to minimum and maximum pulse-width times.

SIGNAL SUMMARY

Table 1 is a summary of all signals discussed in the previous paragraphs.

Table 1. Signal Summary

Signal Name	Direction	Active State	Driver Type	Synchronizing Clock Edge
A8/D0-A23/D15	In/Out	High	Three State	Falling**
A1-A7	In/Out	High	Three State	Falling**
FC0-FC2	Out	High	Three State	_
cs	In	Low	_	Falling
AS	In/Out	Low	Three State*	Falling
R/W	In/Out	High/Low	Three State*	Falling
UDS	In/Out	Low/High	Three State*	Falling
LDS	In/Out	Low	Three State*	Falling
DTACK	In/Out	Low	Three State*	Rising
OWN	Out	Low	Open Drain*	_
UAS	Out	Low	Three State*	_
DBEN	Out	Low	Three State*	_
DDIR	Out	High/Low	Three State*	_
HIBYTE	Out	Low	Three State*	_
BEC0-BEC2	In	Low	_	Rising
BR	Out	Low	Open Drain	
BG	In	Low		Rising
BGACK	In/Out	Low	Open Drain*	_
ĪRQ	In	Low		_
IACK	In	Low	_	Falling
REQ0-REQ3	In	Low		Rising
ACK0-ACK3	Out	Low	Always Driven	_
PCL0-PCL3	In/Out	Programmed	Three State	Rising
DTC	Out	Low	Three State*	
DONE	In/Out	Low	Open Drain	Rising
CLK	ln	_	_	_

^{*}These signals require a pullup resistor to maintain a high voltage when in the high-impedance or negated state. When these signals go to the high-impedance or negated state, they momentarily drive the pin high to reduce the signal rise time.

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^{**}These signals are latched on a clock edge but are not synchronized (i.e., the latched value is used immediately rather than being delayed by one clock).

REGISTER DESCRIPTION

Figure 11 shows the memory-mapped locations of the registers for each channel. Figure 12, the register summary, can be used as a quick reference to the bit definitions within each register.

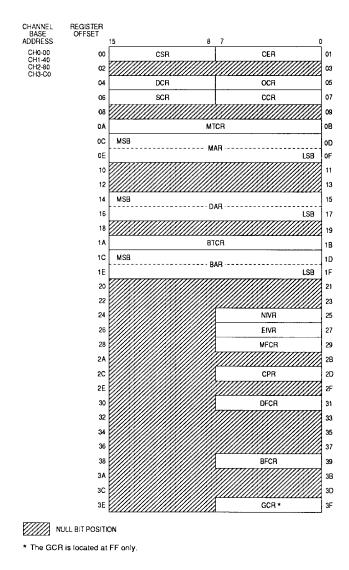
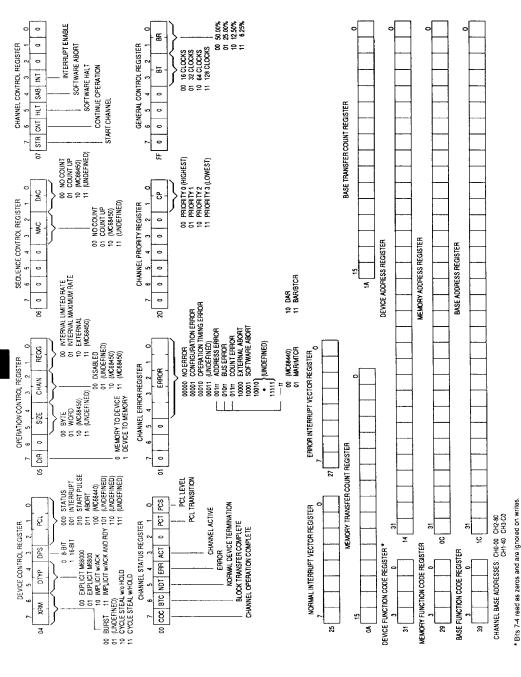


Figure 11. Register Memory Map

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Figure 12. Register Summary

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The register memory map for the MC68450 DMAC is identical to the register memory map for the MC68440 DDMA, including the individual bit assignments within the registers. However, not all functional options available on the DMAC are available on the DDMA and vice versa. If any programmable options labeled "MC68440 Reserved" or "Undefined, Reserved" are programmed into a DMAC channel, a configuration error occurs when the MPU attempts to start that channel.

All registers within the DMAC are always accessible as bytes or words by the MPU (assuming that the MPU can gain control of the DMA bus); however, some registers can not or should not be modified while a channel is actively transferring data. If a register can not be modified during operation and an attempt is made to write to it, an operation timing error is signaled and the channel operation is aborted.

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RESET OPERATION RESULTS

When the DMAC is reset, either during a system power-up sequence or to reinitialize the DMAC, many of the registers will be affected and will be set to known values. Table 2 shows the hexadecimal value that will be placed in each register by a reset operation.

Table 2. Reset Operation Results

Register	Value	Comments
MARc	xxxxxxx	Not Affected
DARc	xxxxxxx	Not Affected
BARc	xxxxxxx	Not Affected
MFCRc	х	Not Affected
DFCRc	×	Not Affected
BFCRc	х	Not Affected
MTCRc	xxxx	Not Affected
BRCRc	xxxx	Not Affected
NIVRc	0F	Uninitialized Vector
EIVRc	0F	Uninitialized Vector
CPRc	00	_
DCRc	00	
OCRc	00	_
SCRc	00	_
CCRc	00	Channel Not Active, Interrupts Disabled
CSRc	00 or 01	(Depending on the Level of PCLc)
CERc	00	No Errors
GCR	00	

X — Indicates an unknown value or the previous value of the register.

c — Indicates the channel number (i.e., 0, 1, 2, or 3).

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ELECTRICAL SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Supply Voltage	v _{cc}	-0.3 to +7.0	٧
Input Voltage	V _{in}	-0.3 to +7.0	٧
Operating Temperature Range	TA	0 to +70	°C
Storage Temperature	T _{stg}	-55 to +150	°C

THERMAL CHARACTERISTICS

	1		
Characteristic	θJA	θЈС	Rating
Thermal Resistance (Still Air)			°C/W
Ceramic (L/LC)	30	15*	
Plastic (P)	30	15*	
Pin Grid Array (R/RC)	30	15	

^{*}Estimated

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum-rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either GND or V_{CC}).

POWER CONSIDERATIONS

The average chip-junction temperature, T_J, in °C can be obtained from:

$$T_{.J} = T_{A} + (P_{D} \cdot \theta_{.JA}) \tag{1}$$

where:

T_A = Ambient Temperature, °C θ_{JA} = Package Thermal Resistance, Junction-to-Ambient, °C/W

 $P_D = P_{INT} + P_{I/O}$

PINT = ICC × VCC, Watts—Chip Internal Power

P_{I/O} = Power Dissipation on Input and Output

Pins-User Determined

For most applications P_{I/O}<P_{INT} and can be neglected.

The following is an approximate relationship between P_D and T_J (if $P_{I/O}$ is neglected):

$$P_D = K \div (T_J + 273^{\circ}C)$$
 (2)

Solving equations (1) and (2) for K gives:

$$K = P_D \cdot (T_A + 273^{\circ}C) + \theta_{JA} \cdot P_D^2$$
 (3)

where K is a constant pertaining to the particular part. K can be determined from equation (3) by measuring P_D (at equilibrium) for a known T_A . Using this value of K, the values of P_D and P_D and P_D are obtained by solving equations (1) and (2) iteratively for any value of P_D .

The total thermal resistance of a package (θ JA can be separated into two components, θ JA and θ CA, representing the barrier to heat flow from the semi-conductor junction to the package (case) surface (θ JC) and from the case to the outside ambient (θ CA). These terms are related by the equation:

$$\theta_{JA} = \theta_{JC} + \theta_{CA} \tag{4}$$

 θ JC is device related and cannot be influenced by the user. However, θ CA is user dependent and can be minimized by such thermal management techniques as heat sinks, ambient air cooling, and thermal convection. Thus, good thermal management on the part of the user can significantly reduce θ CA so that θ JA aproximately equals θ JC. Substitution of θ JC for θ JA in equation (1) will result in a lower semiconductor junction temperature.

Values for thermal resistance presented in this document, unless estimated, were derived using the procedure described in Motorola Reliability Report 7843, "Thermal Resistance Measurement Method for MC68XX Microcomponent Devices," and are provided for design purposes only. Thermal measurements are complex and dependent on procedure and setup. User-derived values for thermal resistance may differ.

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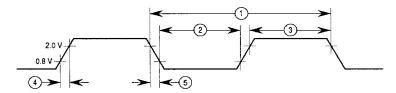
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DC ELECTRICAL SPECIFICATIONS ($T_A = 0^{\circ}C$ to $70^{\circ}C$; $V_{CC} = 5.0 \text{ V } \pm 5\%$)

Characteristic	Symbol	Min	Max	Unit
Input High Voltage	v_{IH}	2.0	v _{cc}	>
Input Low Voltage	V _{IL}	GND -0.3	0.8	٧
Input Leakage Current CS, IACK, BG, CLK, BEC0-BEC2, RE00-RE03	l _{in}		10	μΑ
Three-State (Off-State) Input Current A1-A7, D0/A8-D15/A23, AS, UDS, LDS, R.W, UAS, DTACK, BGACK, OWN, DTC, HIBYTE, DDIR, DBEN, FC0-FC2, PCL0-PCL3	I _T SI	_	20	μА
Input Capacitance (V _{in} = 0 V, T _A = 25°C, f = 1 MHz)	c _{in}	_	15	рF
Open-Drain (Off-State) Input Current IRQ, DONE	^I DD	_	20	μА
Output High Voltage A1–A7, D0/A8–D15/A23, ĀS, IOH = -400 μA UDS, LDS, R/W, DTACK, BGACK, BR, OWN, DTC, HIBYTE, DDIR, DBEN, ACKO-ACK3, PCL0-PCL3, FC0-FC2	v _{он}	2.4		>
Output Low Voltage $\begin{array}{c ccccccccccccccccccccccccccccccccccc$	V _{OL}	_	0.5	V
Power Dissipation at 25°C (Frequency = 8 MHz)	PD		2.0	w
Output Load Capacitance	СГ	_	130	pF

AC ELECTRICAL SPECIFICATIONS — CLOCK INPUT (see Figure 13)

			8 MHz		10 !	I	
Num.	Parameter	Symbol	Min	Max	Min	Max	Unit
	Frequency of Operation	f	2	8	2	10	MHz
1	Clock Time Period	t _{cyc}	125	500	100	500	ns
2,3	Clock Pulse Width	t _{CL} , t _{CH}	55	250	45	250	ns
4,5	Clock Rise and Fall Times	^t Cf ^{, t} Cr	_	10		10	ns



NOTE: Timing measurements are referenced to and from a low voltage of 0.8 V and a high voltage of 2.0 V, unless otherwise noted. The voltage swing through this range should start outside and pass through the range such that the rise or fall will be linear between 0.8 V and 2.0 V.

Figure 13. Clock Input Timing Diagram

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AC ELECTRICAL SPECIFICATIONS — READ AND WRITE CYCLES ($V_{CC} = 15 \text{ V} \pm 5\%$, GND = 0 V, $T_A = 0^{\circ}\text{C}$ to 70°C, unless otherwise noted; see Figures 14–19)

	= 15 V \pm 5%, GND=0 V, I_A = 0°C to 70°C, unle			/iHz	10 MHz		
Num.	Parameter	Symbol	Min	Max	Min	Max	Unit
6	Asynchronous Input Setup Time	t _{ASI}	20	_	15	_	ns
7	Data in to DBEN Low	^t DIDBL	0	_	0	_	ns
8	DTACK Low to Data In Invalid	^t DTLDI	0	_	0	_	ns
9	Address In to AS In Low	t _{AIASL}	0	_	0	_	ns
10	AS In High to Address In Invalid	^t SIHAIV	0	-	0	-	ns
11	Clock High to DDIR Low	t _{CHDRL}	_	70	_	60	ns
12	Clock High to DDIR High	tCHDRH	-	70		60	ns
13	DS In High to DDIR High Impedance	t _{DSHDRZ}	_	120	_	110	ns
14	Clock Low to DBEN Low	^t CLDBL	_	70	_	60	ns
15	Clock Low to DBEN High	^t CLDBH		70	_	60	ns
16	DS In High to DBEN High Impedance	^t DSHDBZ	_	120	_	110	ns
17	Clock High to Data Out Valid (MPU Read)	^t CHDVM	_	180	_	160	ns
18	DS In High to Data Out Invalid	^t DSHDZn	0	_	0	_	ns
19	DS In High to Data High Impedance	^t DSHDZ	_	120	_	110	ns
20	Clock Low to DTACK Low	^t CLDTL	_	70	_	60	ns
21	DS In High to DTACK High	^t DSHDTH		110	_	110	ns
22	DTACK Width High	^t DTH	10	_	10	_	ns
23	DS In High to DTACK High Impedance	t _{DSHDTZ}	_	180	_	160	ns
24	DTACK Low to DS In High	^t DTLDSH	0		0		ns
25	REQ Width Low	tREQL	2.0	_	2.0	_	Clk. Per.
26	REQ Low to BR Low	t _{RELBRL}	250		200	_	ns
27	Clock High to BR Low	^t CHBRL	_	70	_	60	ns
28	Clock High to BR High	^t CHBRH	_	70	_	60	ns
29	BG Low to BGACK Low	t _{BGLBL}	4.5		4.5	_	Cik. Per.
31	MPU Cycle End (AS In High) to BGACK Low	†ASHBL	4.5	5.5	4.5	5.5	Clk. Per.
32	REQ Low to BGACK Low	^t REQLBL	12	[12	_	Clk. Per.
33	Clock High to BGACK Low	^t CHBL		70		60	ns
34	Clock High to BGACK High	^t CHBH		70	_	60	ns
35	Clock Low to BGACK High Impedance	t _{CLBZ}	_	80		70	ns
36	Clock High to FC Valid	^t CHFCV	_	100	_	90	ns
37	Clock High to Address Valid	^t CHAV	_	120	_	110	ns
38	Clock High to Address/FC/Data High Impedance	t _{CHAZx}		100	_	100	ns
39	Clock High to Address/FC/Data Invalid	^t CHAZn	0	_	0	_	ns
40	Clock Low to Address High Impedance (Read)	t _{CLAZ}		100		90	ns

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AC ELECTRICAL SPECIFICATIONS — READ AND WRITE CYCLES

(Continued)

· ·			8 N	1Hz	10 MHz		
Num.	Parameter	Symbol	Min	Max	Min	Max	Unit
41	Clock High to UAS Low	t _{CHUL}	_	70	_	60	ns
42	Clock High to UAS High	t _{CHUH}	_	70	-	60	ns
43	Clock Low to UAS High Impedance	^t CLUZ	_	80	_	70	ns
44	UAS High to Address Invalid	^t UHAI	30	_	20	_	ns
45	Clock High to AS, DS Low	t _{CHSL}	_	60		55	ns
46	Clock Low to DS Low (Write)	t _{CLDSL}		60	_	55	ns
47	Clock Low to AS, DS High	tCLSH	_	70	_	60	ns
48	Clock Low to AS, DS High Impedance	tCLSZ	_	80	_	70	ns
49	AS Width Low	t _{ASL}	255	-	195	_	ns
50	DS Width Low	t _{DSL}	255	_	190	_	ns
51	AS, DS Width High	t _{SH}	150	_	105	_	ns
52	Address/FC Valid to AS, DS Low (Read)	†AVSL	30	-	20	_	ns
53	AS, DS High to Address/FC/Data Invalid	t _{SHAZ}	30		20	_	ns
54	Clock High to R/W Low	t _{CHRL}	_	70	_	60	ns
55	Clock High to R/W High	t _{CHRH}	_	70		60	ns
56	Clock Low to R/W High Impedance	tCLRZ	_	80	_	70	ns
57	Address/FC Valid to R/W Low	†AVRL	20	_	10		ns
58	R/W Low to DS Low (Write)	†RL\$L	120	-	90		ns
59	DS High to R/W High	t _{SHRH}	40	_	20	_	ns
60	Clock Low to OWN Low	tCLOL		70	_	60	ns
61	Clock Low to OWN High	[†] CLOH	_	70		60	ns
62	Clock High to OWN High Impedance	tCHOZ		80	_	70	ns
63	OWN Low to BGACK Low	t _{OLBL}	30		20	_	ns
64	BGACK High to OWN High	t _{BHOH}	30	_	20	_	ns
65	OWN Low to UAS Low	tOLUL	30	_	20	_	ns
66	Clock High to ACK Low (Read)	tCHACL	_	70	_	60	ns
67	Clock Low to ACK Low (Write)	tCLACL		70	_	60	ns
68	Clock High to ACK High	t _{CHACH}	_	70	_	60	ns
69	ACK Low to DS Low	†ACLDSL	100		80	_	ns
70	DS High to ACK High	^t DSHACH	30	_	20	_	ns
71	Clock High to HIBYTE Low	tCHHIL	_	70	_	60	ns
72	Clock Low to HIBYTE Low	tCLHIL	_	70	_	60	ns
73	Clock High to HIBYTE High	t _{CHHIH}	_	70		60	ns
74	Clock Low to HIBYTE High Impedance	tCLHIZ	_	80		70	ns
75	Clock High to DTC Low	t _{CHDTL}	_	70	_	60	ns
76	Clock High to DTC High	t _{CHDTH}		70		60	ns
77	Clock Low to DTC High Impedance	t _{CLDTZ}		80	_	70	ns

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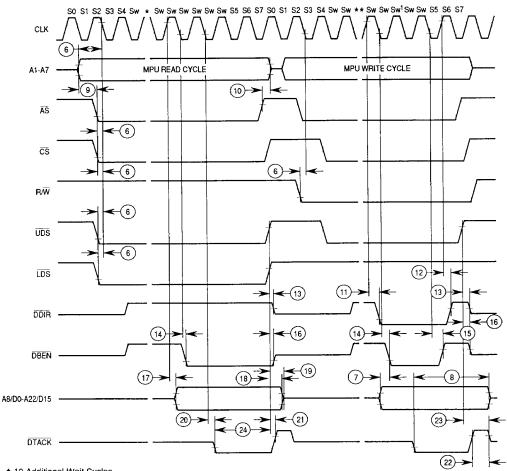
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AC ELECTRICAL SPECIFICATIONS — READ AND WRITE CYCLES

(Concluded)

N			8 MHz		10 MHz		
Num.	Parameter	Symbol	Min	Max	Min	Max	Unit
78	DTC Width Low	t _{DTCL}	105	_	80		ns
79	DTC Low to DS High	t _{DTLDH}	30	_	20	_	ns
80	Clock High to DONE Low	tCHDOL	_	70	_	60	ns
81	Clock Low to DONE Low	^t CLDOL	_	70		60	ns
82	Clock High to DONE High	^t CHDOH	_	130		120	ns
83	Clock High to DDIR High Impedance	t _{CLDRZ}	-	80		70	ns
84	Clock Low to DBEN High Impedance	^t CLDBZ		80	_	70	ns
85	DDIR Low to DBEN Low	^t DRLDBL	30	_	20	_	ns
86	DBEN High to DDIR High	t _{DBHDRH}	30	_	20	_	ns
87	DBEN Low to Address/Data High Impedance	t _{DBLAZ}	_	17		17	ns
88	Clock Low to PCL Low (1/8 Clock)	^t CLPL	_	70	_	60	ns
89	Clock Law to PCL High (1/8 Clock)	t _{CLPH}	_	70	_	60	ns
90	PCL Width Low (1/8 Clock)	tPCLL	4.0	_	4.0	_	Clk. Per.
91	DTACK Low to Data In (Setup Time)	†DALDI	_	150		115	ns
92	DS High to Data Invalid (Hold Time)	^t SHDI	0	_	0		ns
93	DS High to DTACK High	^t SHDAH	0	120	0	90	ns
94	Data Out Valid to DS Low	t _{DOSL}	0	_	0	_	ns
95	Data In to Clock Low (Setup Time)	^t DICL	15	_	15	_	ns
96	BEC Low to DTACK Low	t _{BECDAL}	50	_	50		ns
97	BEC Width Low	^t BECL	2.0		2.0	_	Clk. Per.
98	Clock High to IRQ Low	t _{CHIRL}	_	70	_	60	ns
99	Clock High to IRQ High Impedance	tCHIRH	_	130	_	120	ns
100	PCL (as READY) In to DTC Low (Read)	^t RALDTL	145	_	120	_	ns
101	PCL (as READY) In to DS Low (Write)	^t RALDSL	205	_	170	_	ns
102	DS High to PCL (as READY) High	^t DSHRAH	0	120	0	90	ns
103	DONE In Low to DTACK Low	†DOLDAL	50	_	50		ns
104	DS High to DONE In High	^t DSHDOH	0	120	0	90	ns

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- * 10 Additional Wait Cycles
- * * 8 Additional Wait Cycles

NOTES:

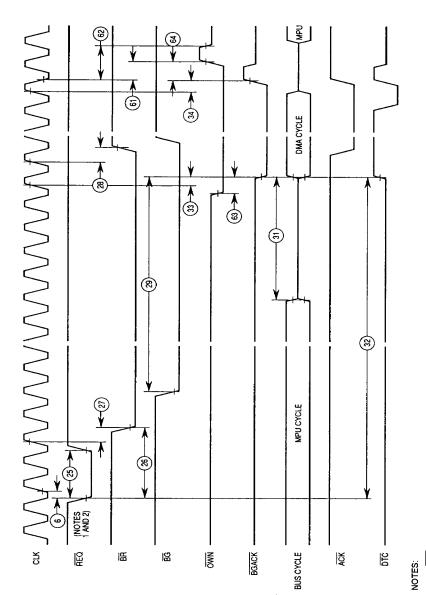
- 1. Data is latched at the end of this clock.
- 2. Timing measurements are referenced to and from a low voltage of 0.8 V and a high voltage of 2.0 V, unless otherwise noted.

Figure 14. MPU Read/Write Timing Diagram

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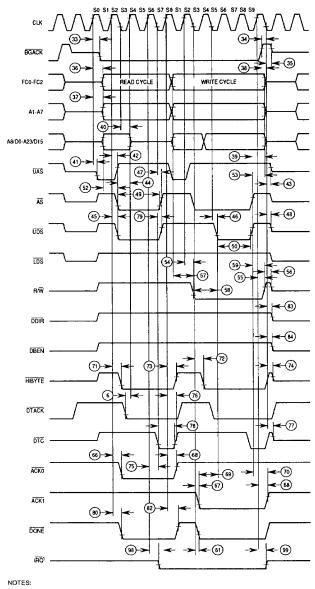
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- 1. $\overline{\text{REQ}}$ is sampled on the rising edge of CLK in cycle-steal and burst modes.
- 3. Timing measurements are referenced to and from a low voltage of 0.8 V and a high voltage of 2.0 V, unless otherwise noted. 2. BR will not be asserted while any BEC exception condition exists or when CS or IACK is asserted.

Figure 15. Bus Arbitration Timing Diagram

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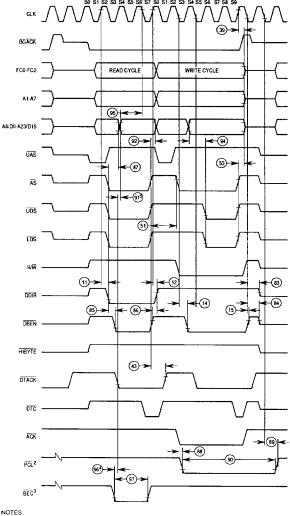
1. This timing is not directly related to the DMA read/write (single cycle) sequence.

Figure 16. DMA Read/Write Timing Diagram (Single Cycle)

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Timing measurements are referenced to and from a low voltage of 0.8 V and a high voltage of 2.0 V, unless otherwise noted.

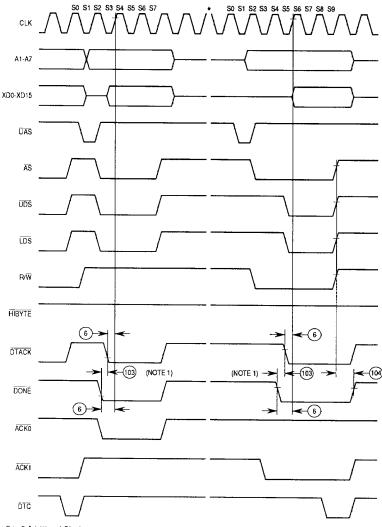


NOTES

- 1. Data is latched at the end of clock S6.
- 2. Timing is not directly related to the DMA read/write (dual cycle) sequence and is only applicable when the start pulse mode is selected.
- 3. Timing is applicable when a bus exception occurs.
- 4. If specification number 6 is satisfied for both DTACK and BEC, specification number 96 may be 0 ns.
- 5. If propagation delay of the external bidirectional buffer is less than 17 ns, a conflict may occur between the address output of the DMAC and the system data bus. In this case, the output of DBEN must be delayed externally
- 6. Timing measurements are referenced to and from a low voltage of 0.8 V and a high voltage of 2.0 V, unless otherwise noted

Figure 17. DMA Read/Write Timing Diagram (Dual Cycle)

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*3 to 9 Additional Clocks

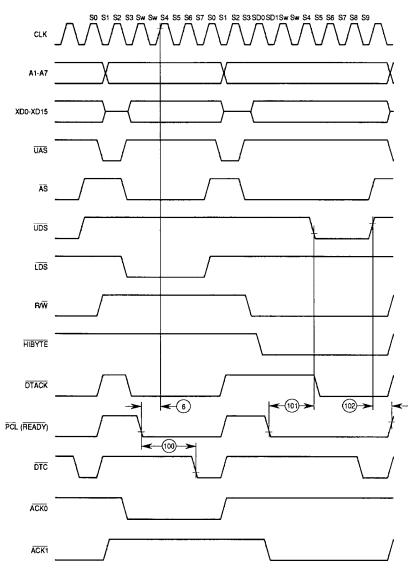
NOTES

- 1. If specification number 6 is satisfied for both DTACK and DONE, specification number 103 may be 0 ns.
- The setup time for asynchronous inputs BG, BGACK, CS, IACK, AS, UDS, LDS, and R/W guarantees
 their recognition at the next falling edge of the clock. The setup time for BEC0-BEC2, REGO-REG3,
 PCL0-PCL3, DTACK, and DONE guarantees their recognition at the next rising edge of the clock.
- Timing measurements are referenced to and from a low voltage of 0.8 V and a high voltage of 2.0 V, unless otherwise noted.

Figure 18. DONE Input Timing Diagram

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NOTE: Timing measurements are referenced to and from a low voltage of 0.8 V and a high voltage of 2.0 V, unless otherwise noted.

Figure 19. DMA Read/Write Timing Diagram (Single Cycle with PCL as READY)

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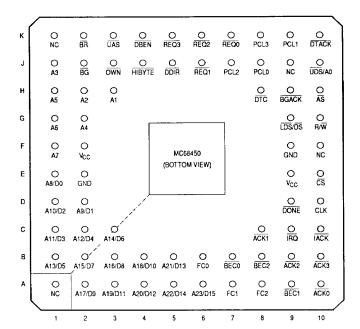
PIN ASSIGNMENTS

68-LEAD DUAL-IN-LINE PACKAGE

,		¬		
REQ3	1 🌘	\bigcirc	64	DDIR
REQ2	2		63	DBEN
REQ1	3		62	HIBYTE
REQ0	4		61	UAS
PCL3	5		60	OWN
PCL2	6		59	BR
PCL1	7		58	⊞BG
PCL0	8		57	A1
BGACK	9		56	A2
DTC	10		55	A3
DTACK	11		54	A4
ÜDS/Ã0	12		53	A5
LDS/DS [13		52	A6
ĀS	14		51	□ Vcc
R/W 🔙	15		50	A7
GND	16	MC68450	49	GND
ĊS☐	17		48	A8/D0
V _{CC}	18		47	A9/D1
CLK	19		46	A10/D2
IACK [20		45	A11/D3
IRQ	21		44	A12/D4
DONE	22		43	A13/D5
ACK3	23		42	A14/D6
ACK2	24		41	A15/D7
ACK1	25		40	A16/D8
ACK0	26		39	A17/D9
BEC2	27		38	A18/D10
BEC1	28		37	A19/D11
BEC0	29		36	A20/D12
FC2	30		35	A21/D13
FC1	31		34	A22/D14
FC0	32		33	A23/D15
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